

DG211

SPST 4-Channel Analog Switch

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FN3118 Rev 5.00 November 19, 2007

The DG211 is a low cost, CMOS monolithic, Quad SPST analog switch. It can be used in general purpose switching applications for communications, instrumentation, process control and computer peripheral equipment and provides true bi-directional performance in the ON condition and blocks signals to $30V_{P-P}$ in the OFF condition.

Ordering Information

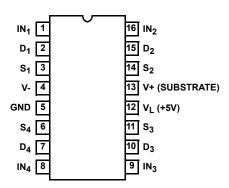
PART NUMBER	PART MARKING	TEMP. RANGE (°C)	PACKAGE	PKG. DWG.#
DG211CJ	DG211CJ	0 to +70	16 Ld PDIP	E16.3
DG211CJZ (Note)	DG211CJZ	0 to +70	16 Ld PDIP* (Pb-free)	E16.3
DG211CY**	DG211CY	0 to +70	16 Ld SOIC	M16.15
DG211CYZ** (Note)	DG211CYZ	0 to +70	16 Ld SOIC (Pb-free)	M16.15
DG211CVZ** (Note)	DG211 CVZ	0 to +70	16 Ld TSSOP (Pb-free)	M16.173

^{*}Pb-free PDIPs can be used for through hole wave solder processing only. They are not intended for use in Reflow solder processing applications.

NOTE: These Intersil Pb-free plastic packaged products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate PLUS ANNEAL - e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

Pinout

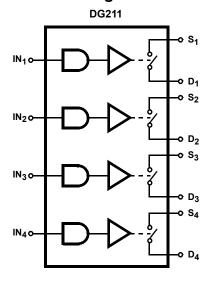
DG211 (16 LD PDIP, SOIC, TSSOP) TOP VIEW



Features

- · Switches ±15V Analog Signals
- · TTL Compatibility
- Logic Inputs Accept Negative Voltages
- Pb-Free Available (RoHS Compliant)

Functional Block Diagram



TRUTH TABLE

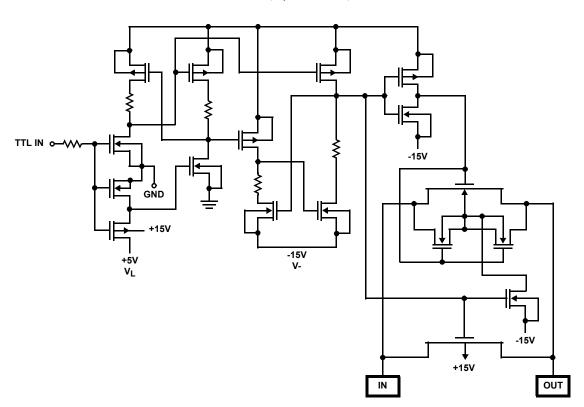
LOGIC	DG211
0	ON
1	OFF

Logic "0" ≤0.8V, Logic "1" ≥ 2.4V

^{**}Add "-T" suffix for tape and reel. Please refer to TB347 for details on reel specifications.

Schematic Diagram

DG211 (¹/₄ AS SHOWN)



Absolute Maximum Ratings

V+ to V
V _{IN} to Ground
V _L to Ground0.3V to 25V
V _S or V _D to V+
V _S or V _D to V
V+ to Ground
V- to Ground25V
Current, any Terminal Except S or D
Continuous Current, S or D 20mA
Peak Current, S or D (Pulsed 1ms, 10% Duty Cycle Max) 70mA

Thermal Information

Thermal Resistance (Typical, Note 1)	θ_{JA} (°C/W)
PDIP Package*	100
SOIC Package	
TSSOP Package	150
Maximum Junction Temperature	
Maximum Storage Temperature Range65°	'C to +150°C
Pb-free reflow profile	ee link below
http://www.intersil.com/pbfree/Pb-FreeReflow.asp	

*Pb-free PDIPs can be used for through hole wave solder processing only. They are not intended for use in Reflow solder processing applications.

Operating Conditions

Temperature Range 0°C to +70°C

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTE

1. θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

Electrical Specifications V+ = +15V, V- = -15V, $V_L = +5V$, GND, $T_A = +25$ °C

PARAMETER	TEST CONDITIONS		MIN (Notes 2, 6)	TYP (Note 3)	MAX (Notes 2, 6)	UNITS
DYNAMIC CHARACTERISTICS			•	1		
Turn-ON Time, t _{ON}	See Figure 1		-	460	-	ns
Turn-OFF Time	$V_S = 10V$, $R_L = 1k\Omega$, C	C _L = 35pF				
t _{OFF1}			-	360	-	ns
t _{OFF2}			-	450	-	ns
OFF Isolation, OIRR (Note 5)		L = 15pF, V _S = 1V _{RMS} ,	-	70	-	dB
Crosstalk (Channel-to-Channel), CCRR	f = 100kHz		-	-90	-	dB
Source OFF-Capacitance, C _{S(OFF)}	$V_D = V_S = 0V, V_{IN} = 5$	V, f = 1MHz	-	5	-	pF
Drain OFF-Capacitance, C _{D(OFF)}		-	5	-	pF	
Channel ON-Capacitance, C _{D(ON)} + C _{S(ON)}		-	16	-	pF	
DIGITAL INPUT CHARACTERISTICS				1		
Input Current with Voltage High, I _{IH}	V _{IN} = 2.4V		-1.0	-0.0004	-	μΑ
	V _{IN} = 15V		-	0.003	1.0	μΑ
Input Current with Voltage Low, I _{IL}	V _{IN} = 0V		-1.0	-0.0004	-	μΑ
ANALOG SWITCH CHARACTERISTICS				1		
Analog Signal Range, V _{ANALOG}			-15	-	15	٧
Drain-Source ON-Resistance, r _{DS(ON)}	$V_D = \pm 10V, I_S = 1mA,$	V _{IN} = 0.8V	-	150	175	Ω
Source OFF Leakage Current, I _{S(OFF)}	V _{IN} = 2.4V	V _S = 14V, V _D = -14V	-	0.01	5.0	nA
		V _S = -14V, V _D = 14V	-5.0	-0.02	-	nA
Drain OFF Leakage Current, I _{D(OFF)}		V _S = -14V, V _D = 14V	-	0.01	5.0	nA
		V _S = 14V, V _D = -14V	-5.0	-0.02	-	nA
Drain ON Leakage Current, I _{D(ON)}	V _{IN} = 0.8V	V _S = V _D = 14V	-	0.1	5.0	nA
(Note 4)	V _S = V _D = -14V		-5.0	-0.15	-	nA



Electrical Specifications V+ = +15V, V- = -15V, $V_1 = +5V$, GND, $T_A = +25^{\circ}C$ (Continued)

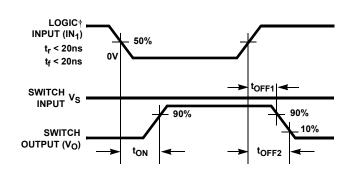
PARAMETER	TEST CONDITIONS	MIN (Notes 2, 6)	TYP (Note 3)	MAX (Notes 2, 6)	UNITS	
POWER SUPPLY CHARACTERISTICS						
Positive Supply Current, I+	V _{IN} = 0V or 2.4V	-	0.1	10	μΑ	
Negative Supply Current, I-		-	0.1	10	μΑ	
Logic Supply Current, I _L		-	0.1	10	μΑ	

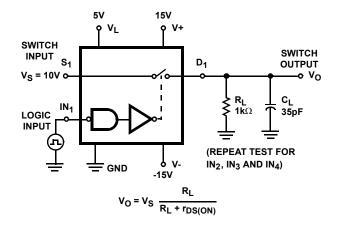
NOTES:

- 2. The algebraic convention whereby the most negative value is a minimum, and the most positive is a maximum, is used in this data sheet.
- 3. For design reference only, not 100% tested.
- 4. I_{D(ON)} is leakage from driver into ON switch.
- 5. OFF Isolation = $20log \frac{V_S}{V_D}$, V_S = Input to OFF switch, V_D = output .
- 6. Parts are 100% tested at +25°C. Over-temperature limits established by characterization and are not production tested.

Test Circuits and Waveforms

Switch output waveform shown for V_S = constant with logic input waveform as shown. Note the V_S may be + or - as per switching time test circuit. V_O is the steady state output with switch on. Feedthrough via gate capacitance may result in spikes at leading and trailing edge of output waveform.





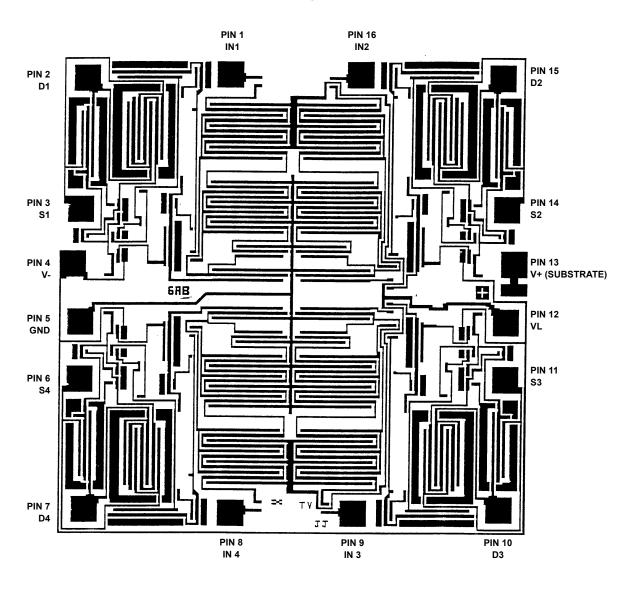
† Logic shown for DG211.

FIGURE 1. SWITCHING TIME MEASUREMENT POINTS

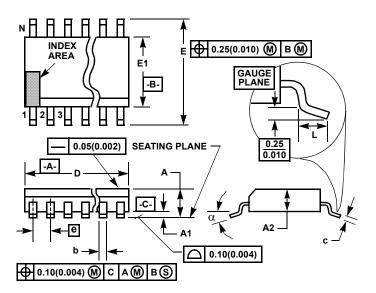
FIGURE 2. SWITCHING TIME TEST CIRCUIT

Metallization Mask Layout

DG211



Thin Shrink Small Outline Plastic Packages (TSSOP)



NOTES:

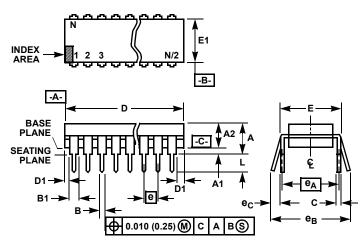
- These package dimensions are within allowable dimensions of JEDEC MO-153-AB, Issue E.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- Dimension "E1" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.15mm (0.006 inch) per side.
- 5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- 6. "L" is the length of terminal for soldering to a substrate.
- 7. "N" is the number of terminal positions.
- 8. Terminal numbers are shown for reference only.
- Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.08mm (0.003 inch) total in excess of "b" dimension at maximum material condition. Minimum space between protrusion and adjacent lead is 0.07mm (0.0027 inch).
- 10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact. (Angles in degrees)

M16.173
16 LEAD THIN SHRINK SMALL OUTLINE PLASTIC PACKAGE

TO LEAD THIN OTHER COMME OF EACH OF ACKAGE						
	INC	HES	MILLIMETERS			
SYMBOL	MIN	MAX	MIN MAX		NOTES	
Α	-	0.043	-	1.10	-	
A1	0.002	0.006	0.05	0.15	-	
A2	0.033	0.037	0.85	0.95	-	
b	0.0075	0.012	0.19	0.30	9	
С	0.0035	0.008	0.09	0.20	-	
D	0.193	0.201	4.90	5.10	3	
E1	0.169	0.177	4.30	4.50	4	
е	0.026	BSC	0.65	BSC	-	
Е	0.246	0.256	6.25	6.50	-	
L	0.020	0.028	0.50	0.70	6	
N	1	6	1	6	7	
α	0°	8 ⁰	0°	8º	-	

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Dual-In-Line Plastic Packages (PDIP)



NOTES:

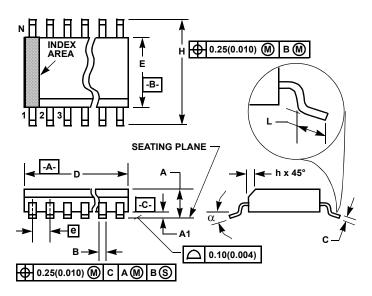
- Controlling Dimensions: INCH. In case of conflict between English and Metric dimensions, the inch dimensions control.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication No. 95.
- Dimensions A, A1 and L are measured with the package seated in JE-DEC seating plane gauge GS-3.
- D, D1, and E1 dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010 inch (0.25mm).
- E and e_A are measured with the leads constrained to be perpendicular to datum -C-.
- 7. e_B and e_C are measured at the lead tips with the leads unconstrained. e_C must be zero or greater.
- B1 maximum dimensions do not include dambar protrusions. Dambar protrusions shall not exceed 0.010 inch (0.25mm).
- 9. N is the maximum number of terminal positions.
- Corner leads (1, N, N/2 and N/2 + 1) for E8.3, E16.3, E18.3, E28.3, E42.6 will have a B1 dimension of 0.030 - 0.045 inch (0.76 - 1.14mm).

E16.3 (JEDEC MS-001-BB ISSUE D)
16 LEAD DUAL-IN-LINE PLASTIC PACKAGE

	INCHES		MILLIMETERS		
SYMBOL	MIN	MAX	MIN	MIN MAX	
Α	-	0.210	-	5.33	4
A1	0.015	-	0.39	-	4
A2	0.115	0.195	2.93	4.95	-
В	0.014	0.022	0.356	0.558	-
B1	0.045	0.070	1.15	1.77	8, 10
С	0.008	0.014	0.204	0.355	-
D	0.735	0.775	18.66	19.68	5
D1	0.005	-	0.13	-	5
Е	0.300	0.325	7.62	8.25	6
E1	0.240	0.280	6.10	7.11	5
е	0.100	BSC	2.54 BSC		-
e _A	0.300	BSC	7.62 BSC		6
e _B	-	0.430	-	10.92	7
L	0.115	0.150	2.93	3.81	4
N	1	6	16		9

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Small Outline Plastic Packages (SOIC)



NOTES:

- Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs.
 Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- 4. Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
- The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- 6. "L" is the length of terminal for soldering to a substrate.
- 7. "N" is the number of terminal positions.
- 8. Terminal numbers are shown for reference only.
- The lead width "B", as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch).
- Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

M16.15 (JEDEC MS-012-AC ISSUE C)
16 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE

	INCHES		MILLIM			
SYMBOL	MIN	MAX	MIN	MAX	NOTES	
Α	0.0532	0.0688	1.35	1.75	-	
A1	0.0040	0.0098	0.10	0.25	-	
В	0.013	0.020	0.33	0.51	9	
С	0.0075	0.0098	0.19	0.25	-	
D	0.3859	0.3937	9.80	10.00	3	
Е	0.1497	0.1574	3.80	4.00	4	
е	0.050	BSC	1.27 BSC		-	
Н	0.2284	0.2440	5.80	6.20	-	
h	0.0099	0.0196	0.25	0.50	5	
L	0.016	0.050	0.40	1.27	6	
N	1	6	1	6	7	
α	0°	8°	0°	8°	-	

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